



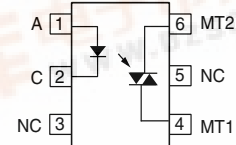
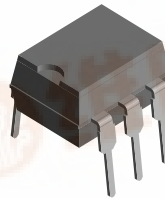
# BRT11/ 12/ 13

Vishay Semiconductors

## Optocoupler, Phototriac Output

### Features

- $I_{TRMS} = 300 \text{ mA}$
- High Static  $dV_{CRQ}/dt < 10,000 \text{ V}/\mu\text{s}$
- Electrically Insulated between Input and output circuit
- Microcomputer compatible - Very Low Trigger Current
- Non-zero voltage detectors High input Sensitivity



1179041

### Agency Approvals

- UL - File No. E52744 System Code J
- DIN EN 60747-5-2(VDE0884)  
DIN EN 60747-5-5 pending  
Available with Option 1

### Applications

Industrial controls  
Office equipment  
Consumer appliances

### Description

The BRT11/12/13 are AC optocouplers non-zero voltage detectors consisting of two electrically insulated lateral power ICs which integrate a thyristor system, a photo detector and noise suppression at the output and an IR GaAs diode input.

### Order Information

| Part         | Remarks  |
|--------------|--|
| BRT11-H      | 400 V $V_{DRM}$ , 2 mA $I_{FT}$ , DIP-6                    |
| BRT12-H      | 600 V $V_{DRM}$ , 2 mA $I_{FT}$ , DIP-6                    |
| BRT13-H      | 800 V $V_{DRM}$ , 2 mA $I_{FT}$ , DIP-6                    |
| BRT11-M      | 400 V $V_{DRM}$ , 3 mA $I_{FT}$ , DIP-6                    |
| BRT12-M      | 600 V $V_{DRM}$ , 3 mA $I_{FT}$ , DIP-6                    |
| BRT13-M      | 800 V $V_{DRM}$ , 3 mA $I_{FT}$ , DIP-6                    |
| BRT12-H-X006 | 600 V $V_{DRM}$ , 2 mA $I_{FT}$ , DIP-6 400 mil (option 6) |
| BRT12-H-X007 | 600 V $V_{DRM}$ , 2 mA $I_{FT}$ , SMD-6 (option 7)         |
| BRT12-H-X009 | 600 V $V_{DRM}$ , 2 mA $I_{FT}$ , SMD-6 (option 9)         |
| BRT13-H-X006 | 800 V $V_{DRM}$ , 2 mA $I_{FT}$ , DIP-6 400 mil (option 6) |
| BRT13-H-X007 | 800 V $V_{DRM}$ , 2 mA $I_{FT}$ , SMD-6 (option 7)         |
| BRT13-H-X009 | 800 V $V_{DRM}$ , 2 mA $I_{FT}$ , SMD-6 (option 9)         |
| BRT12-M-X006 | 600 V $V_{DRM}$ , 3 mA $I_{FT}$ , DIP-6 400 mil (option 6) |

For additional information on the available options refer to Option Information.



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## Absolute Maximum Ratings

$T_{amb} = 25\text{ °C}$ , unless otherwise specified

Stresses in excess of the absolute Maximum Ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute Maximum Rating for extended periods of the time can adversely affect reliability.

## Input

| Parameter                  | Test condition           | Symbol     | Value | Unit |
|----------------------------|--------------------------|------------|-------|------|
| Reverse voltage            |                          | $V_R$      | 6     | V    |
| Forward continuous current |                          | $I_F$      | 20    | mA   |
| Surge forward current      |                          | $I_{FSM}$  | 1.5   | A    |
| Power dissipation          | $t \leq 10\ \mu\text{s}$ | $P_{diss}$ | 30    | mW   |

## Output

| Parameter                         | Test condition | Part  | Symbol     | Value | Unit |
|-----------------------------------|----------------|-------|------------|-------|------|
| Repetitive peak off-state voltage |                | BRT11 | $V_{DRM}$  | 400   | V    |
|                                   |                | BRT12 | $V_{DRM}$  | 600   | V    |
|                                   |                | BRT13 | $V_{DRM}$  | 800   | V    |
| RMS on-state current              |                |       | $I_{TRMS}$ | 300   | mA   |
| Single cycle surge current        | 50 Hz          |       | $I_{TSM}$  | 3     | A    |
| Power dissipation                 |                |       | $P_{diss}$ | 600   | mW   |

## Coupler

| Parameter   | Test condition                                   | Symbol    | Value          | Unit      |
|---|--|-----------|----------------|-----------|
| Max. power dissipation  |  | $P_{tot}$ | 630            | mW        |
| Ambient temperature   |  | $T_{amb}$ | - 40 to + 100  | °C        |
| Storage temperature   |  | $T_{stg}$ | - 40 to + 150  | °C        |
| Insulation test voltage <sup>1)</sup><br>between input/output circuit<br>(climate in acc. with DIN 40046,<br>part 2, Nov. 74) |  | $V_{ISO}$ | 5300           | $V_{RMS}$ |
| Reference voltage in acc. with<br>VDE 0110 b  |  | $V_{ref}$ | 500            | $V_{RMS}$ |
| Reference voltage in acc. with<br>VDE 0110 b (insulation group C)   |  | $V_{ref}$ | 600            | $V_{DC}$  |
| Creepage resistance (in acc.<br>with DIN IEC 112/VDE 0303,<br>part 1)   | (group IIIa acc. to DIN VDE<br>0109)             | CTI       | 175            |           |
| Insulation resistance   | $V_{IO} = 500\text{ V}, T_{amb} = 25\text{ °C}$  | $R_{IO}$  | $\geq 10^{12}$ | $\Omega$  |
|   | $V_{IO} = 500\text{ V}, T_{amb} = 100\text{ °C}$ | $R_{IO}$  | $\geq 10^{11}$ | $\Omega$  |
| DIN humidity category,<br>DIN 40 040  |  |           | F              |           |
| Creepage distance<br>(input/output circuit)   |  |           | $\geq 7.2$     | mm        |
| Clearance (input/output circuit)  |  |           | $\geq 7.2$     | mm        |

<sup>1)</sup> Test AC voltage in acc. with DIN 57883, June 1980



## Electrical Characteristics

$T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified

Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluation. Typical values are for information only and are not part of the testing requirements.

### Input

| Parameter   | Test condition       | Symbol     | Min | Typ. | Max  | Unit                 |
|---|----------------------|------------|-----|------|------|----------------------|
| Forward voltage                                     | $I_F = 10\text{ mA}$ | $V_F$      |     | 1.1  | 1.35 | V                    |
| Reverse current                                     | $V_R = 6\text{ V}$   | $I_R$      |     |      | 10   | $\mu\text{A}$        |
| Thermal resistance <sup>2)</sup> junction - ambient |                      | $R_{thja}$ |     |      | 750  | $^{\circ}\text{C/W}$ |

<sup>2)</sup> Static air, SITAC soldered in pcb or base plate.

### Output

| Parameter   | Test condition   | Symbol        | Min | Typ. | Max | Unit                    |
|---|--|---------------|-----|------|-----|-------------------------|
| Critical rate of rise of off-state voltage              | $V_D = 0.67 V_{DRM}, T_J = 25\text{ }^{\circ}\text{C}$   | $dV/dt_{cr}$  | 10  |      |     | $\text{kV}/\mu\text{s}$ |
|   | $V_D = 0.67 V_{DRM}, T_J = 80\text{ }^{\circ}\text{C}$   | $dV/dt_{cr}$  | 5   |      |     | $\text{kV}/\mu\text{s}$ |
| Critical rate of rise of voltage at current commutation | $V_D = 0.67 V_{DRM}, T_J = 25\text{ }^{\circ}\text{C},$<br>$di/dt_{crq} \leq 15\text{ A/ms}$           | $dV/dt_{crq}$ | 10  |      |     | $\text{kV}/\mu\text{s}$ |
|   | $V_D = 0.67 V_{DRM}, T_J = 80\text{ }^{\circ}\text{C},$<br>$di/dt_{crq} \leq 15\text{ A/ms}$           | $dV/dt_{crq}$ | 5   |      |     | $\text{kV}/\mu\text{s}$ |
| Critical rate of rise of on-state current               |  | $di/dt_{cr}$  | 8   |      |     | $\text{A}/\mu\text{s}$  |
| Pulse current   | $t_p \leq 5\text{ }\mu\text{s}, f 0\text{ }100\text{ Hz},$<br>$di_{tp}/dt \leq 8\text{ A}/\mu\text{s}$ | $I_{tp}$      |     |      | 2   | A                       |
| On-state voltage  | $I_T = 300\text{ mA}$  | $V_T$         |     |      | 2.3 | V                       |
| Off-state current                                       | $T_C = 80\text{ }^{\circ}\text{C}, V_{DRM}$  | $I_D$         |     | 0.5  | 100 | $\mu\text{A}$           |
| Holding current   | $V_D = 10\text{ V}$  | $I_H$         |     | 80   | 500 | $\mu\text{A}$           |
| Thermal resistance <sup>2)</sup> junction - ambient     | $R_{thJA}$   | $R_{thja}$    |     |      | 125 | $^{\circ}\text{C/W}$    |

<sup>2)</sup> Static air, SITAC soldered in pcb or base plate.

### Coupler

| Parameter                            | Test condition                           | Symbol                     | Min | Typ. | Max | Unit                           |
|--------------------------------------|--|----------------------------|-----|------|-----|--------------------------------|
| Trigger current                      | $V_D = 10\text{ V}, \text{H - Versions}$ | $I_{FT}$                   | 0.4 |      | 2   | mA                             |
|                                      | $V_D = 10\text{ V}, \text{M - Versions}$ | $I_{FT}$                   | 0.8 |      | 3   | mA                             |
| Trigger current temperature gradient |  | $\Delta I_{FT}/\Delta T_j$ |     | 7    | 14  | $\mu\text{A}/^{\circ}\text{C}$ |
| Capacitance (input-output)           | $V_R = 0\text{ V}, f = 1\text{ kHz}$     | $C_{IO}$                   |     |      | 2   | pF                             |

## Typical Characteristics ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ unless otherwise specified)

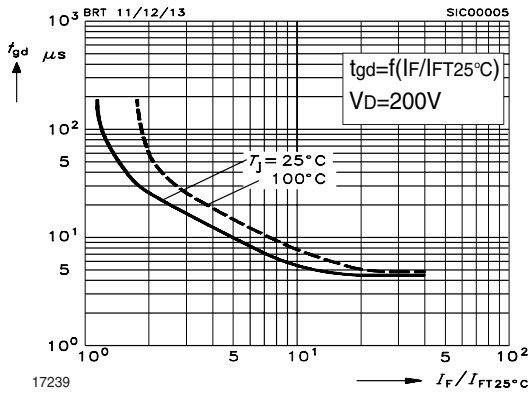


Fig. 1 Typical Trigger Delay Time

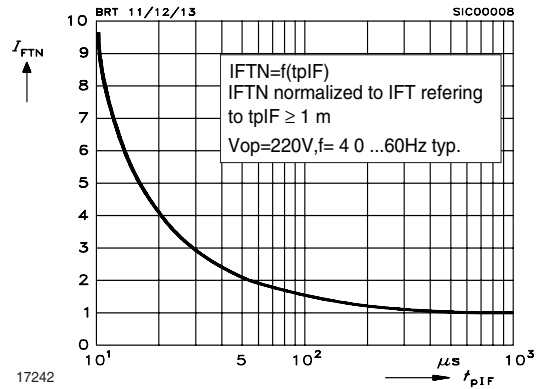


Fig. 4 Pulse Trigger Current

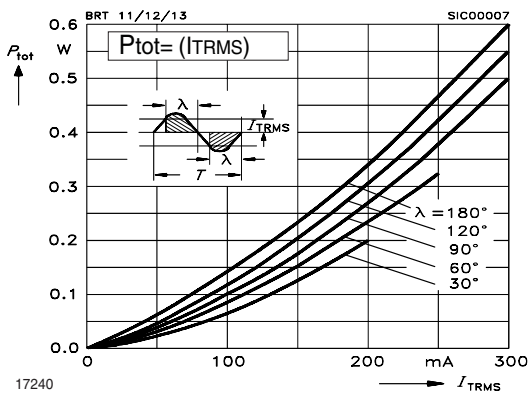


Fig. 2 Power Dissipation 40 to 60 Hz Line Operation

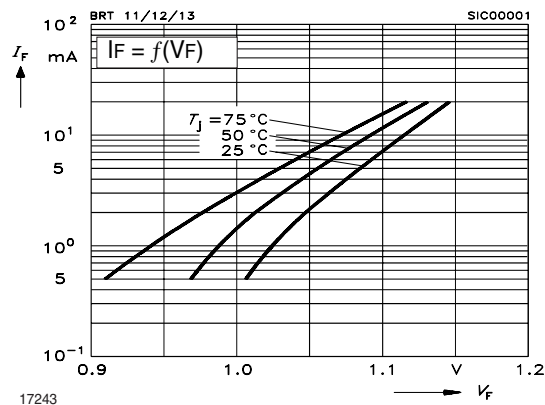


Fig. 5 Typical Input Characteristics

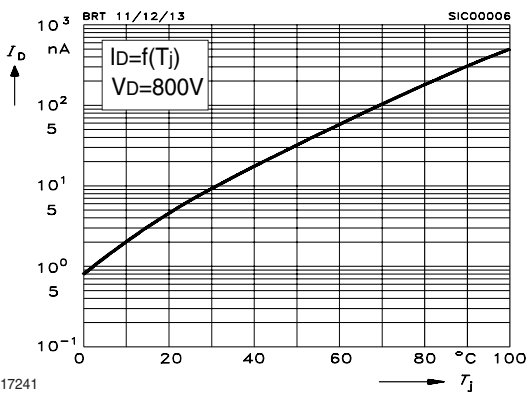


Fig. 3 Typical Off-State Current

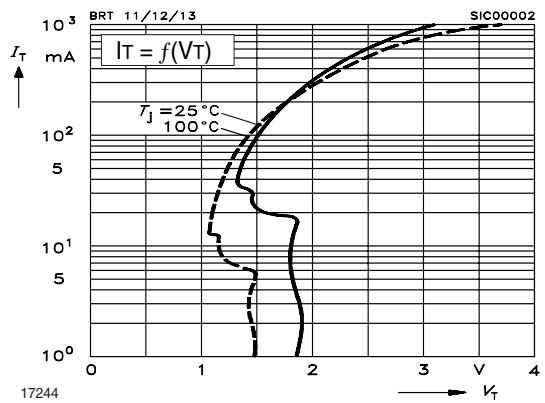


Fig. 6 Typical Output Characteristics



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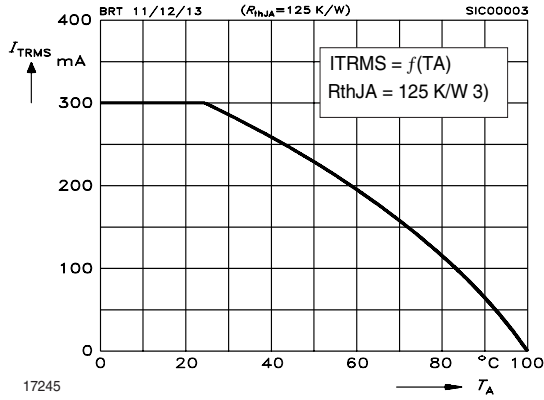


Fig. 7 Current Reduction

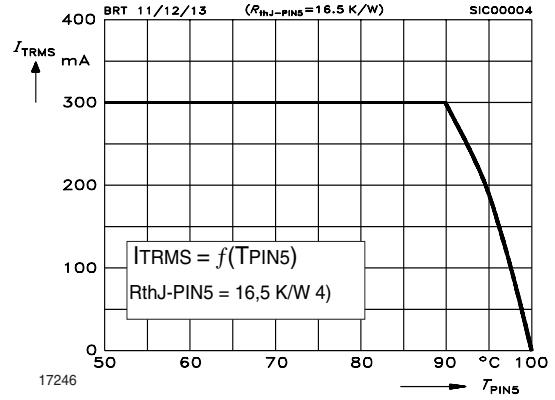
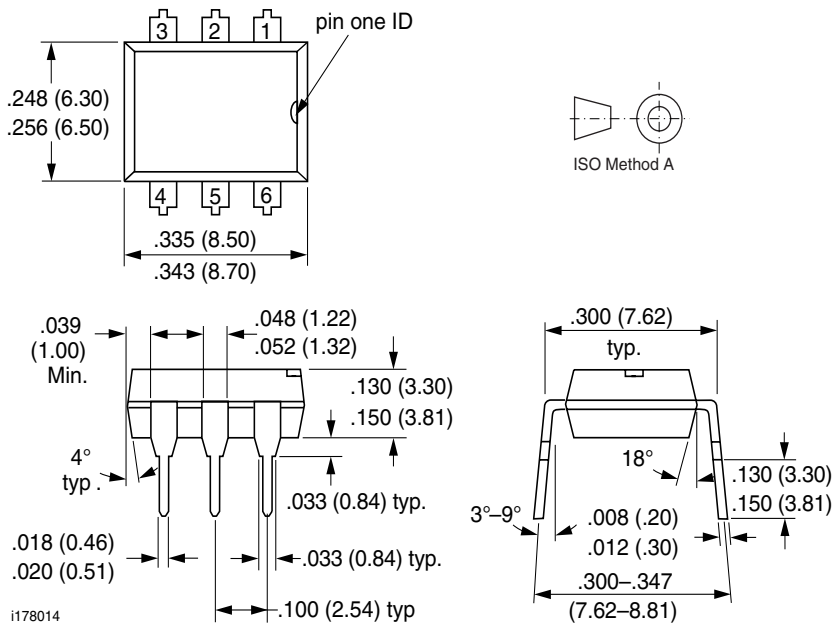


Fig. 8 Current Reduction

## Package Dimensions in Inches (mm)

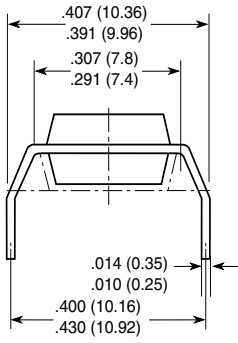


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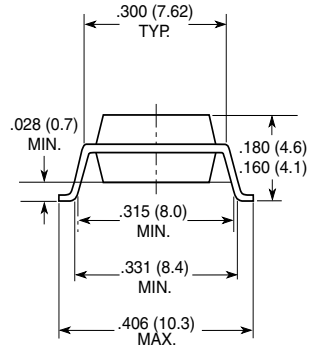
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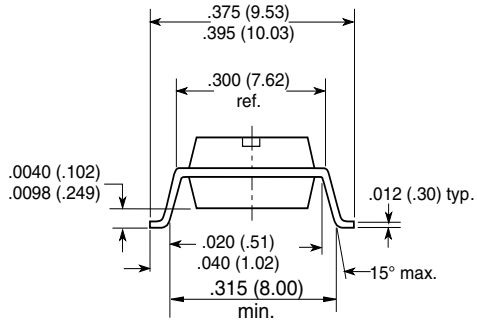
Option 6



Option 7



Option 9



18450



## **Ozone Depleting Substances Policy Statement**

It is the policy of **Vishay Semiconductor GmbH** to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

**Vishay Semiconductor GmbH** has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

**Vishay Semiconductor GmbH** can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

### **We reserve the right to make changes to improve technical design and may do so without further notice.**

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

Vishay Semiconductor GmbH, P.O.B. 3535, D-74025 Heilbronn, Germany  
Telephone: 49 (0)7131 67 2831, Fax number: 49 (0)7131 67 2423